

DB-960-90W

90W / 26V / 925-960 MHz PA using 2x PD57060S The *LdmosST* FAMILY

N-CHANNEL ENHANCEMENT-MODE LATERAL MOSFETs

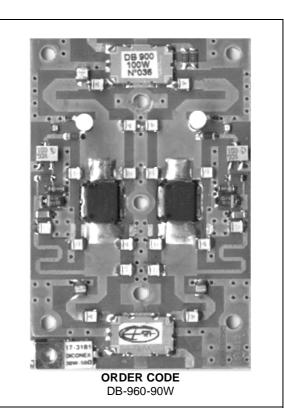
- EXCELLENT THERMAL STABILITY
- COMMON SOURCE CONFIGURATION
- P_{OUT} = 90 W min. with 13 dB gain over 925-960 MHz
- 10:1 LOAD VSWR CAPABILITY
- BeO FREE AMPLIFIER.

DESCRIPTION

The DB-960-90W is a common source N-Channel enhancement-mode lateral Field-Effect RF power amplifier designed for GSM/GPRS/EDGE base station applications.

The DB-960-90W is designed in cooperation with Europeenne de Telecomunications S.A. (www.et-sa.rf), for high gain and broadband performance operating in common source mode at 26 V, capable of withstanding load mismatch up to 10:1 all phases and with harmonics lower than 30 dBc.

PRELIMINARY DATA



MECHANICAL SPECIFICATION L=80 mm W=50 mm H=10 mm

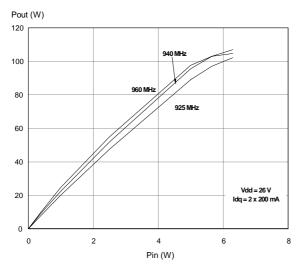
Symbol	Parameter	Value	Unit
V _{DD}	Supply voltage	32 V	
Ι _D	Drain Current	12	А
P _{DISS}	Power Diss. at Tcase = +85°C	145 W	
T _{CASE}	Operating Case Temperature	-20 to +85	°C
P _{amb}	Max. Ambient Temperature	+55 °C	

ABSOLUTE MAXIMUM RATINGS (T_{CASE} = 25°C)

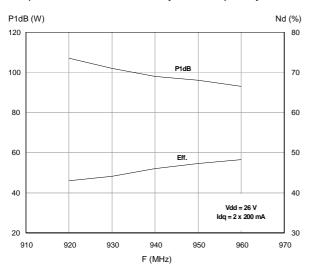
DB-960-90W

Symbol	Test Conditions	Min.	Тур.	Max.	Unit
FREQ.	Frequency Range	925		960	MHz
Gain	P _{OUT} = 90 W	12	13		dB
P _{1dB}	Over frequency range: 925 - 960 MHz	90	100		W
Flatness	Over frequency range and @ P _{OUT} = 90 W			+/- 0.5	dB
Flatness	P _{OUT} from 0.1W to 90 W			1	dB
ND at P _{1dB}	P _{1dB}	40	45		%
IRTL	Input return Loss P _{OUT} from 0.1W to 90 W		-20	-15	dB
Harmonic	P _{OUT} = 90 W			-30	dBc
VSWR	Load Mismatch all phases @ P _{OUT} = 90 W	10:1			
Spurious	10:1 VSWR all phases and P _{OUT} from 0.1 to 90 W			-76	dBc
IMD ₃	P _{OUT} = 90 WPEP			-25	dBc

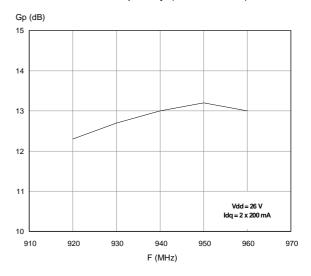
TYPICAL PERFORMANCE Output Power vs. Input Power



Output Power and Efficiency vs. Frequency

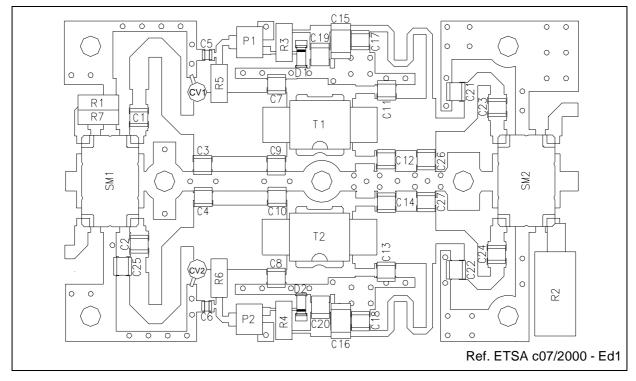


Power Gain vs. Frequency (Pout = 90W)

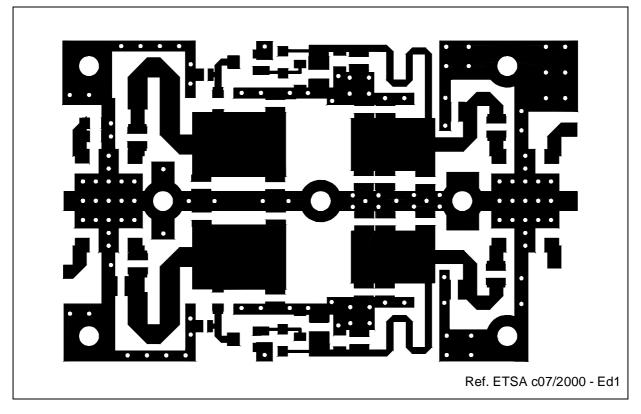


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TEST FIXTURE COMPONENT LAYOUT



TEST CIRCUIT PHOTOMASTER



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DB-960-90W

TEST CIRCUIT COMPONENT PART LIST

COMPONENT	DESCRIPTION			
T1, T2	PD57060S TRANSISTOR			
C1, C2, C23, C24	47pF - 500V CERAMIC CHIP CAPACITOR			
C3, C4	3.3pF - 500V CERAMIC CHIP CAPACITOR			
C5, C6, C17, C18	100pF - 500V CERAMIC CHIP CAPACITOR			
C7, C8, C9, C10, C11, C13	10pF - 500V CERAMIC CHIP CAPACITOR			
C12, C14	6.8pF - 500V CERAMIC CHIP CAPACITOR			
C15, C16	100nF - 63V CERAMIC CHIP CAPACITOR			
C19, C20	1µF / 35V ELECTROLYTIC CAPACITOR			
C21, C22, C26, C27	3.3pF - 500V CERAMIC CHIP CAPACITOR			
C25	0.5pF - 500V CERAMIC CHIP CAPACITOR			
CV1, CV2	ADJUSTABLE CAPACITOR 0.6 - 4.5pF / 500V			
P1, P2	10K Ohms MULTITURN POTENTIOMETER			
R1,R7	100 Ohms 1/4W 1206 SMD CHIP RESISTOR			
R2	50 Ohms 30W - 4GHz LOAD			
R3, R4	4.7K Ohms 1/4W 1206 SMD CHIP RESISTOR			
R5, R6	10K Ohms 1/4W 1206 SMD CHIP RESISTOR			
D1, D2	ZENER DIODE 5V - 500 mW SOD80			
SM1, SM2	90° SMD HYBRID COUPLER ANAREN Xinger 1304-3			
BOARD	METCLAD MX3-30-C1/10C THK 0.762 mm Cu 35µ			
SUBSTRATE	TEFLON-GLASS Er = 2.55			
BACK SIDE	COPPER FLANGE 2 mm THICKNESS			
CERAMIC CHIP CAPACITORS	ATC100B or EQUIVALENT			

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